T-51-11

CD4066A Types

CMOS Quad Bilateral Switch

For Transmission or Multiplexing of Analog or Digital Signals

RCA CD4066A is a quad bilateral switch intended for the transmission or multiplexing of analog or digital signals. It is pin-for-pin compatible with RCA-CD4016, but exhibits a much lower ON resistance. In addition, the ON resistance is relatively constant over the full input-signal range.

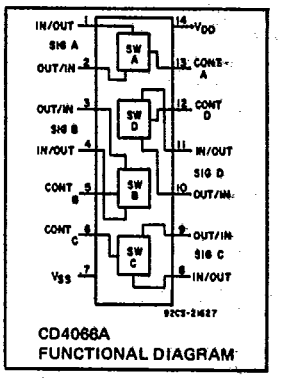
The CD4066A consists of four independent bilateral switches. A single control signal is required per switch. Both the p and the n device in a given switch are biased ON or OFF simultaneously by the control signal. As shown in Fig. 1, the well of the n-channel device on each switch is either tied to the input when the switch is ON or to V_{SS} when the switch is OFF. This configuration eliminates the variation of the switch-transistor threshold voltage with input signal, and thus keeps the ON resistance low over the full operating-signal range.

The advantages over single-channel switches include peak input-signal voltage swings equal to the full supply voltage, and more constant ON impedance over the input-signal range. For sample-and-hold applications, however, the CD4016 is recommended.

These types are supplied in 14-lead hermetic dual-in-line ceramic packages (D and F suffixes), 14-lead dual-in-line plastic package (E suffix), 14-lead ceramic flat package (K suffix), and in chip form (H suffix).

Features:

- 15-V digital or ± 7.5-V peak-to-peak switching
- 80Ω typical ON resistance for 15-V operation
- Switch ON resistance matched to within 5 Ω over 15-V signal-input range
- ON resistance flat over full peak-to-peak signal range
- High ON/OFF output-voltage ratio: 65 dB typ. @ f_{is} = 10 kHz, R_L = 10 kΩ
- High degree of linearity: < 0.5% distortion typ. @ f_{is} = 1 kHz, V_{is} = 5 V_{p-p}, $V_{DD}-V_{SS} \geq$ 10 V, R_L = 10 kΩ
- Extremely low OFF switch leakage resulting in very low offset current and high effective OFF resistance: 10 pA typ. @ $V_{DD}-V_{SS}$ = 10 V, T_A = 25°C
- Extremely high control input impedance (control circuit isolated from signal circuit): 10^{12} Ω typ.
- Low crosstalk between switches: -50 dB typ. @ f_{is} = 0.9 MHz, R_L = 1 kΩ
- Matched control-input to signal-output capacitance: Reduces output signal transients
- Frequency response, switch ON = 40 MHz (typ.)
- Quiescent current specified to 15-V
- Maximum control input leakage current of 1-μA at 15-V (Full package-temperature range)



CD4066A
FUNCTIONAL DIAGRAM

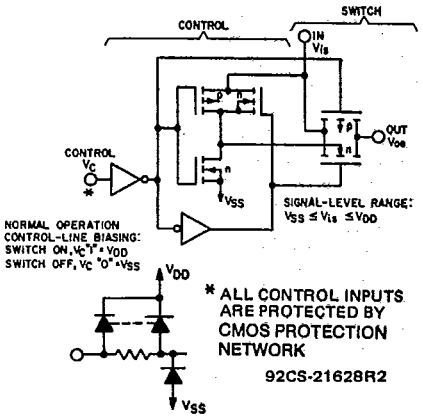


Fig. 1 – Schematic diagram of 1 of 4 identical switches and its associated control circuitry.

MAXIMUM RATINGS, *Absolute-Maximum Values:*

STORAGE TEMPERATURE RANGE (T_{stg}) . . . . . -65 to +125°C

OPERATING TEMPERATURE RANGE (T_A):

PACKAGE TYPES D, F, K, H. . . . . -55 to +125°C

PACKAGE TYPE E . . . . . -40 to +85°C

DC SUPPLY VOLTAGE RANGE, V_{DD}

(Voltages referenced to V_{SS}) . . . . . -0.5 to +15 V

INPUT CURRENT (TRANSMISSION GATE INCL.) . . . . . ±10 mA

POWER DISSIPATION PER PACKAGE:

FOR T_A = -40 to +60°C (PACKAGE TYPE E) . . . . . 500 mW

FOR T_A = +60 to +85°C (PACKAGE TYPE E) Derate Linearly at 12 mW/°C . . . . . 200 mW

FOR T_A = -55 to +100°C (PACKAGE TYPES D, F, K) . . . . . 500 mW

FOR T_A = +100 to +125°C (PACKAGE TYPES D, F, K) Derate Linearly at 12 mW/°C . . . 200 mW

DEVICE DISSIPATION PER SECTION:

FOR T_A = FULL PACKAGE-TEMPERATURE RANGE (ALL PACKAGE TYPES) . . . . . 100 mW

ALL SIGNAL AND DIGITAL CONTROL INPUTS . . . . . $V_{SS} \leq V_I \leq V_{DD}$

LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16 ± 1/32 inch (1.59 ± 0.79 mm) from case for 10 s max. . . . . +265°C

SPECIAL CONSIDERATIONS – CD4066A

1. In applications where separate power sources are used to drive V_{DD} and the signal inputs, the V_{DD} current capability should exceed V_{DD}/R_L (R_L = effective external load of the 4 CD4066A bilateral switches). This provision avoids any permanent current flow or clamp action on the V_{DD} supply when power is applied or removed from CD4066A.
2. In certain applications, the external load-resistor current may include both V_{DD} and signal-line components. To avoid drawing V_{DD} current when switch current flows into terminals 1, 4, 8, or 11, the voltage drop across the bidirectional switch must not exceed 0.8 volt (calculated from R_{ON} values shown).

   No V_{DD} current will flow through R_L if the switch current flows into terminals 2, 3, 9, or 10.
3. Minimum bilateral switch output load resistance is 100 Ω.

OPERATING CONDITIONS AT T_A = 25°C

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	V_{DD}	MIN.	MAX.	UNITS
Supply Voltage Range (T_A = Full Package Temperature Range)	–	3	12	V

CD4066A Types

Applications:

- Analog signal switching/multiplexing
  - Signal gating
  - Squelch control
  - Chopper
  - Modulator
  - Demodulator
  - Commutating switch
- Digital signal switching/Multiplexing
- Transmission-gate logic implementation
- Analog-to-digital & digital-to-analog conversion
- Digital control of frequency, impedance, phase, and analog-signal gain

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	TEST CONDITIONS *All Voltage Values Are in Volts*			LIMITS Values at -55°C, +25°C, +125°C Apply to D, F, K, H Packages Values at -40°C, +25°C, +85°C Apply to E Package						UNITS
			V_{DD} (V)	-55°	-40°	+85°	+125°	+25° TYP.	+25° MAX.	
Quiescent Device Current, I_L max. D, F, H Pkgs.			5	0.25	–	–	7.5	0.01	0.25	μA
			10	0.5	–	–	15	0.01	0.5	
			15	2	–	–	40	0.02	2	
E Pkg.			5	–	2.5	15	–	0.25	2.5	μA
			10	–	5	30	–	0.25	5	
			15	–	50	500	–	0.5	50	
SIGNAL INPUTS (V_{is}) AND OUTPUTS (V_{os})										
ON Resistance, R_{ON} Max.	$V_C = V_{DD}$	V_{SS}	V_{is}							Ω
	$R_L = 10k\Omega$*									
	+7.5	-7.5	-7.5 to +7.5	220	250	300	320	80	280	
	+15	0	0 to +15							
	+5	-5	-5 to +5	400	450	520	550	120	500	
	+10	0	0 to +10							
	+2.5	-2.5	-2.5 to +2.5	3000	3500	5200	5500	270	5000	
	-5	0	0 to +5							
Δ ON Resistance Between Any 2 of 4 Switches, ΔR_{ON}	$R_L = 10k\Omega$*									Ω
	+7.5 or +15	-7.5 or 0	+7.5 to -7.5 / +15 to 0	–	–	–	–	5	–	
	+5 or +10	-5 or 0	+5 to -5 / +10 to 0	–	–	–	–	10	–	
Sine Wave Response (Distortion)	+5	-5	5V p-p[▲]	–	–	–	–	0.4	–	%
	$R_L = 10k\Omega$, $f_{is} = 1kHz$									
Frequency Response Switch ON (Sine-Wave Input)	+5	-5	-5 p-p	–	–	–	–	40	–	MHz
	$R_L = 1k\Omega$, $20\log_{10}\frac{V_{os}}{V_{is}} = -3dB$									
Feedthrough-Switch OFF	+5	-5	-5 p-p	–	–	–	–	1.25	–	MHz
	$R_L = 1k\Omega$, $20\log_{10}\frac{V_{os}}{V_{is}} = -50dB$									
Input or Output Leakage – Switch OFF (Effective OFF Resistance)	V_{DD}	$V_C = V_{SS}$	±7.5	–	–	–	–	±0.1	±100*	nA
	+7.5	-7.5								
	+5	-5	±5	–	–	–	–	±0.1	±100*	
Crosstalk Between Any 2 of the 4 Switches (f at -50 dB)	$V_C(A) = V_{DD} = +5$, $V_C(B) = V_{SS} = -5$, $R_L = 1k\Omega$, $20\log_{10}\frac{V_{os}(B)}{V_{is}(A)} = -50dB$		(A) 5V p-p	–	–	–	–	0.9	–	MHz

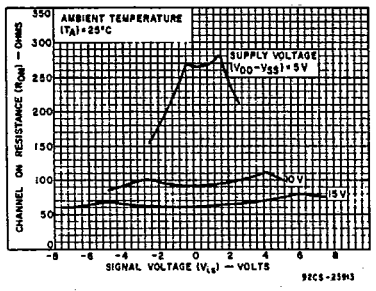


Fig. 2 (a) – Typical channel ON resistance vs. signal voltage for three values of supply voltage ($V_{DD}-V_{SS}$).

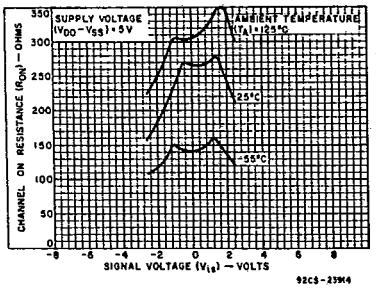


Fig. 2 (b) – Typical channel ON resistance vs. signal voltage with supply voltage ($V_{DD}-V_{SS}$) = 5 V.

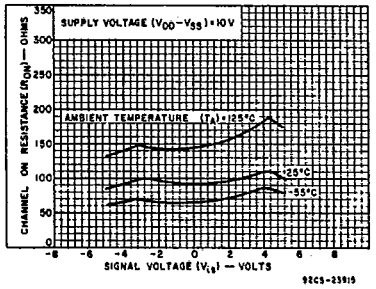


Fig. 2 (c) – Typical channel ON resistance vs. signal voltage with supply voltage ($V_{DD}-V_{SS}$) = 10 V.

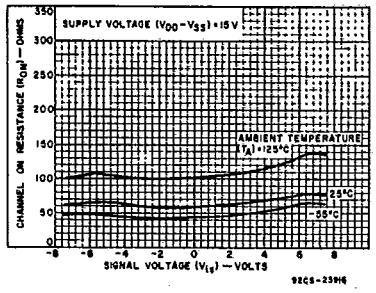


Fig. 2 (d) – Typical channel ON resistance vs. signal voltage with supply voltage ($V_{DD}-V_{SS}$) = 15 V.

CD4066A Types

ELECTRICAL CHARACTERISTICS (Cont'd)

CHARACTERISTIC	TEST CONDITIONS All Voltage Values Are in Volts		LIMITS Values at -55°C, +25°C, +125°C Apply to D, F, K, H Packages; Values at -40°C, +25°C, +85°C Apply to E Package						UNITS
		V_{DD} (V)	-55°	-40°	+85°	+125°	+25° TYP.	+25° MAX.	
Propagation Delay (Signal Input to Signal Output) t_{pd}	$V_C = V_{DD}$, V_{SS} = GND, C_L = 15pF, V_{is} = sq. wave, t_r, t_f = 20 ns (Input Signal)	V_{DD} = 5	–	–	–	–	20	50	ns
		V_{DD} = 10	–	–	–	–	10	25	
Capacitance: Input, C_{is}	V_{DD} = +5, $V_{CC} = V_{SS}$ = -5		–	–	–	–	8	–	pF
Output, C_{os}			–	–	–	–	8	–	
Feedthrough, C_{ios}			–	–	–	–	0.5	–	
CONTROL (V_C)									
Noise Immunity, V_{NL} Min.	$V_{is} \leq V_{DD}$, I_{is} = 10μA, $V_{DD} - V_{SS}$ = 10		2	2	2	2	2 min 4.5	–	V
Input Leakage Current, I_{IL} Max.	$V_{is} \leq V_{DD}$, $V_{DD} - V_{SS}$ = 15, $V_C \leq V_{DD} - V_{SS}$		±1				$\pm 10^{-6}$	±1	μA
Crosstalk Control Input to Signal Output	$V_{DD} - V_{SS}$ = 10, V_C = 10 (sq. wave), $t_{rc} = t_{fc}$ = 20 ns	R_L = 10kΩ	–	–	–	–	50	–	mV
Propagation Delay, t_{pdC}		R_L = 300kΩ, $V_{is} \leq 10$, C_L = 15pF	–	–	–	–	35	–	ns
Maximum Allowable Control Input Repetition Rate	V_{DD} = 10, V_{SS} = GND, R_L = 1kΩ, C_L = 15pF, V_C = 10 (sq. wave), t_r, t_f = 20 ns		–	–	–	–	10	–	MHz
Av. Input Capacitance, C_I			–	–	–	–	5	–	pF

• Limit determined by minimum feasible leakage measurement for automatic testing.

Δ Symmetrical about 0 volts. • For all test conditions.

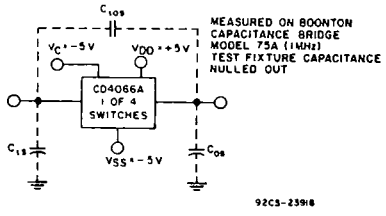


Fig. 6 – Capacitance test circuit.

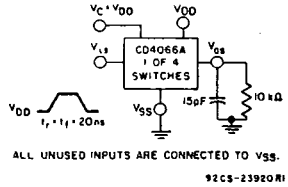


Fig. 8 – Propagation delay time signal input (V_{is}) to signal output (V_{os}).

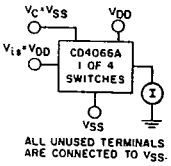


Fig. 7 – OFF switch input or output leakage.

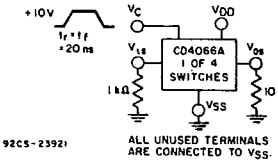


Fig. 9 – Crosstalk-control input to signal output.

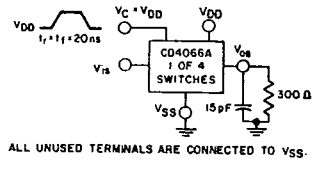


Fig. 11 – Propagation delay t_{PLH}, t_{PHL} control-signal output.

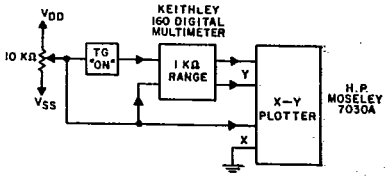


Fig. 3 – Channel ON resistance measurement circuit.

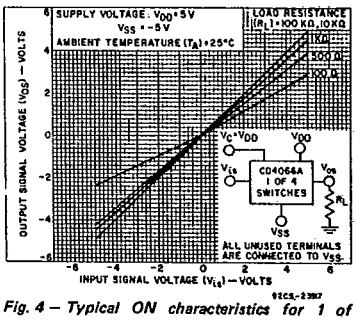


Fig. 4 – Typical ON characteristics for 1 of 4 channels.

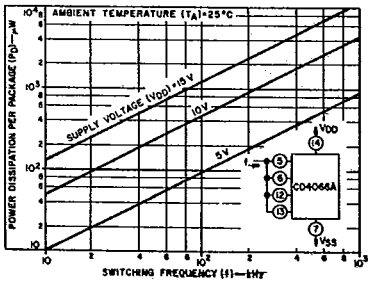


Fig. 5 – Power dissipation per package vs. switching frequency.

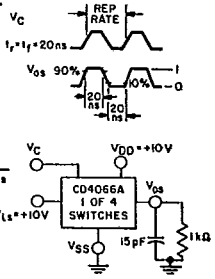


Fig. 10 – Maximum allowable control input repetition rate.

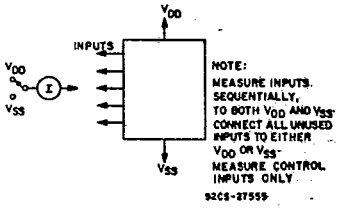
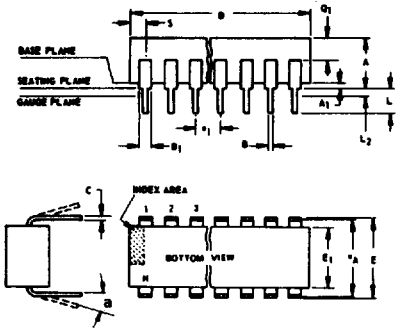


Fig. 12 – Input leakage current test circuit.

Dimensional Outlines

Dual-In-Line Welded-Seal Ceramic Packages



NOTES:
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

(D) SUFFIX (JEDEC MO-001-AD)
14-Lead Dual-In-Line Welded-Seal Ceramic Package

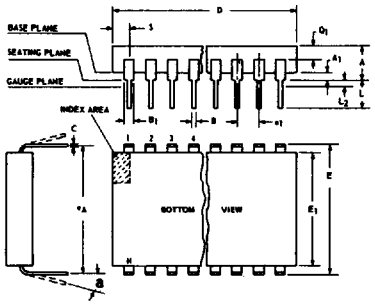
SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.160		3.05	4.06
A_1	0.020	0.065		0.51	1.65
B	0.014	0.020		0.356	0.508
B_1	0.050	0.065		1.27	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.76
α	0°	15°	4	0°	15°
N	14		5	14	
N_1	0		6	0	
Q_1	0.050	0.085		1.27	2.15
S	0.065	0.090		1.66	2.28

92SS-4411R2

(D) SUFFIX (JEDEC MO-001-AE)
16-Lead Dual-In-Line Welded-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.160		3.05	4.06
A_1	0.020	0.065		0.51	1.65
B	0.014	0.020		0.356	0.508
B_1	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.785		18.93	19.93
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.76
α	0°	15°	4	0°	15°
N	16		5	16	
N_1	0		6	0	
Q_1	0.050	0.085		1.27	2.15
S	0.015	0.060		0.39	1.52

92SS-4286R5



NOTES:
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

(D) SUFFIX (JEDEC MO-015-AG)
24-Lead Dual-In-Line Welded-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.090	0.200		2.29	5.08
A_1	0.020	0.070		0.51	1.78
B	0.015	0.020		0.381	0.508
B_1	0.045	0.055		1.143	1.397
C	0.008	0.012	1	0.204	0.304
D	1.15	1.22		29.21	30.98
E	0.600	0.625		15.24	15.87
E_1	0.480	0.520		12.20	13.20
e_1	0.100 TP		2	2.54 TP	
e_A	0.600 TP		2,3	15.24 TP	
L	0.100	0.180		2.54	4.57
L_2	0.000	0.030		0.00	0.76
α	0°	15°	4	0°	15°
N	24		5	24	
N_1	0		6	0	
Q_1	0.020	0.080		0.51	2.03
S	0.020	0.060		0.51	1.52

92CS-19948R4

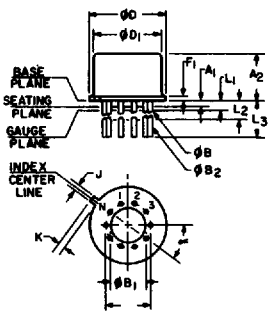
(D) SUFFIX (JEDEC MO-015-AH)
28-Lead Dual-In-Line Welded-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.090	0.200		2.29	5
A_1	0	0.070	2	0	1.77
B	0.015	0.020		0.381	0.508
B_1	0.015	0.055		0.39	1.39
C	0.008	0.012	1	0.204	0.304
D	1.380	1.420		35.06	36.06
E	0.600	0.625		15.24	15.87
E_1	0.485	0.515		12.32	13.08
e_1	0.100 TP		2	2.54 TP	
e_A	0.600 TP		2,3	15.24 TP	
L	0.100	0.200		2.8	5
L_2	0	0.030		0	0.76
α	0°	15°	4	0°	15°
N	28		5	28	
N_1	0		6	0	
Q_1	0.020	0.070		0.51	1.77
S	0.040	0.070		1.02	1.77

92CM-20250R2

TO-5 Style Package

(T) SUFFIX (JEDEC MO-006-AG)
12-Lead Metal Package



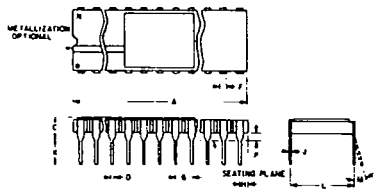
92CS-19774

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
a	0.230		2	5.84 TP	
A_1	0	0		0	0
A_2	0.165	0.185		4.19	4.70
ϕB	0.016	0.019	3	0.407	0.482
ϕB_1	0	0		0	0
ϕB_2	0.016	0.021	3	0.407	0.533
ϕD	0.335	0.370		8.51	9.39
ϕD_1	0.305	0.335		7.75	8.50
F_1	0.020	0.040		0.51	1.01
j	0.028	0.034		0.712	0.863
k	0.029	0.045	4	0.74	1.14
L_1	0.000	0.050	3	0.00	1.27
L_2	0.250	0.500	3	6.4	12.7
L_3	0.500	0.562	3	12.7	14.27
α	30° TP			30° TP	
N	12		6	12	
N_1	1		5	1	

NOTES:
1. Refer to Rules for Dimensioning Axial Lead Product Outlines.
2. Leads at gauge plane within 0.007" (0.178 mm) radius of True Position (TP) at maximum material condition.
3. ϕB applies between L_1 and L_2. ϕB_2 applies between L_2 and 0.500" (12.70 mm) from seating plane. Diameter is uncontrolled in L_1 and beyond 0.500" (12.70 mm).
4. Measure from Max. ϕD.
5. N_1 is the quantity of allowable missing leads.
6. N is the maximum quantity of lead positions.

Dimensional Outlines (Cont'd)

DUAL-IN-LINE SIDE-BRAZED CERAMIC PACKAGES



NOTES:
1. Leads within 0.005" (0.13 mm)-radius of True Position at maximum material condition.
2. Dimension "L" to center of leads when formed parallel.
3. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).

(D) SUFFIX
18-Lead Dual-In-Line
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.890	0.915		22.606	23.241
C	–	0.200		–	5.080
D	0.015	0.021		0.381	0.533
F	0.054 REF.		1	1.371 REF.	
G	0.100 BSC		1	2.54 BSC	
H	0.035	0.065		0.889	1.651
J	0.008	0.012	3	0.203	0.304
K	0.125	0.150		3.175	3.810
L	0.290	0.310	2	7.366	7.874
M	0°	15°		0°	15°
P	0.025	0.045		0.635	1.143
N	18			18	

92CS-27231R1

(D) SUFFIX
22-Lead Dual-In-Line
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.065	1.100		27.05	27.94
C	0.085	0.145		2.16	3.68
D	0.017	0.023		0.43	0.58
F	0.040 REF.		1	1.02 REF.	
G	0.100 BSC		1	2.54 BSC	
H	0.030	0.070		0.76	1.78
J	0.008	0.012	3	0.20	0.30
K	0.125	0.175		3.18	4.45
L	0.380	0.420	2	9.65	10.67
M	–	7°		–	7°
P	0.025	0.050		0.64	1.27
N	22			22	

92CS-26186R2

(D) SUFFIX
24-Lead Dual-In-Line
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.180	1.220		29.98	30.98
C	0.085	0.145		2.16	3.68
D	0.015	0.023		0.39	0.58
F	0.040 REF.			1.02 REF.	
G	0.100 BSC		1	2.54 BSC	
H	0.030	0.070		0.77	1.77
J	0.008	0.012	3	0.21	0.30
K	0.125	0.175		3.18	4.44
L	0.580	0.620	2	14.74	15.74
M	–	7°		–	7°
P	0.025	0.050		0.64	1.27
N	24			24	

92CS-30986R1

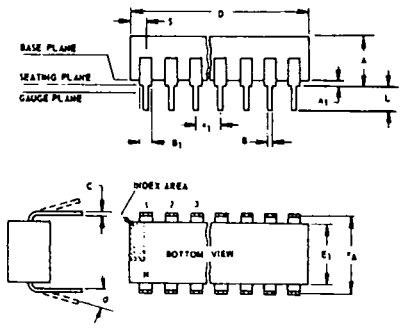
(D) SUFFIX
40-Lead Dual-In-Line
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.980	2.020		50.30	51.30
C	0.095	0.155		2.43	3.93
D	0.017	0.023		0.43	0.56
F	0.050 REF.			1.27 REF.	
G	0.100 BSC		1	2.54 BSC	
H	0.030	0.070		0.76	1.78
J	0.008	0.012	3	0.20	0.30
K	0.125	0.175		3.18	4.45
L	0.580	0.620	2	14.74	15.74
M	–	7°		–	7°
P	0.025	0.050		0.64	1.27
N	40			40	

92CM-27029R2

Dual-In-Line Plastic and Frit-Seal Ceramic Packages

(E) SUFFIX (JEDEC MO-001-AN)
8-Lead Dual-In-Line Plastic
(Mini-DIP) Package



SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.050		0.508	1.27
B	0.014	0.020		0.356	0.508
B_1	0.035	0.065		0.889	1.65
C	0.008	0.012	1	0.203	0.304
D	0.370	0.400		9.40	10.16
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.762
α	0	15	4	0	15
N	8		5	8	
N_1	0		6	0	
Q_1	0.040	0.075		1.02	1.90
S	0.015	0.060		0.381	1.52

92CS-24026RI

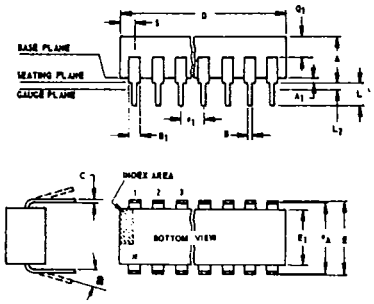
NOTES:

Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.

1. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013".
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at guage plane with maximum material condition and unit installed.
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

Dimensional Outlines (Cont'd)

Dual-In-Line Plastic and Frit-Seal Ceramic Packages (Cont'd)

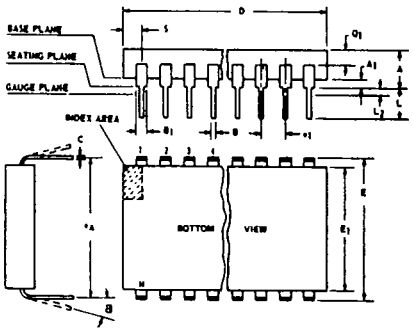


NOTES:
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

(E) SUFFIX
18-Lead Dual-In-Line
Plastic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.050		0.508	1.27
B	0.014	0.020		0.356	0.508
B_1	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.845	0.885		21.47	22.47
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2,3	7.62 TP	
L	0.125	0.150		3.18	3.81
α	0°	15°	4	0°	15°
N	18		5	18	
N_1	0		6	0	
S	0.015	0.060		0.39	1.52

92CS-30630



NOTES.
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder dipped, the maximum lead thickness (narrow portion) will not exceed 0.013".
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at guage plane with maximum material condition and unit installed
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

(E) and (F) SUFFIXES (JEDEC MO-001-AB)
14-Lead Dual-In-Line Plastic or
Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.060		0.51	1.27
B	0.014	0.020		0.356	0.508
B_1	0.050	0.065		1.27	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	14		5	14	
N_1	0		6	0	
Q_1	0.040	0.075		1.02	1.90
S	0.065	0.090		1.66	2.28

92SS-4296R3

(E) SUFFIX
22-Lead Dual-In-Line
Plastic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.050		0.508	1.27
B	0.015	0.020		0.381	0.508
B_1	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D		1.120			28.44
E	0.390	0.420		9.91	10.66
E_1	0.345	0.355		8.77	9.01
e_1	0.100 TP		2	2.54 TP	
e_A	0.400 TP		2, 3	10.16 TP	
L	0.125	0.150		3.18	3.81
L_2	0	0.030		0	0.762
a	2°	15°	4	2°	15°
N	22		5	22	
N_1	0		6	0	
Q_1	0.055	0.085		1.40	2.15
S	0.015	0.060		0.381	1.27

92CS-30830

(E) and (F) SUFFIXES (JEDEC MO-015-AA)
24-Lead Dual-In-Line Plastic or
Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.250		3.10	6.30
A_1	0.020	0.070		0.51	1.77
B	0.016	0.020		0.407	0.508
B_1	0.028	0.070		0.72	1.77
C	0.008	0.012	1	0.204	0.304
D	1.20	1.29		30.48	32.76
E	0.600	0.625		15.24	15.87
E_1	0.515	0.580		13.09	14.73
e_1	0.100 TP		2	2.54 TP	
e_A	0.600 TP		2,3	15.24 TP	
L	0.100	0.200		2.54	5.00
L_2	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	24		5	24	
N_1	0		6	0	
Q_1	0.040	0.075		1.02	1.90
S	0.040	0.100		1.02	2.54

92CS26938R2

(E) and (F) SUFFIXES (JEDEC MO-001-AC)
16-Lead Dual-In-Line Plastic or
Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.050		0.51	1.27
B	0.014	0.020		0.356	0.508
B_1	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.785		18.93	19.93
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	16		5	16	
N_1	0		6	0	
Q_1	0.040	0.075		1.02	1.90
S	0.015	0.060		0.39	1.52

92CM-15967R4

(F) SUFFIX (JEDEC MO-001-AG)
16-Lead Dual-In-Line
Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.165	0.210		4.20	5.33
A_1	0.015	0.045		0.381	1.14
B	0.015	0.020		0.381	0.508
B_1	0.045	0.070		1.15	1.77
C	0.009	0.011	1	0.229	0.279
D	0.750	0.795		19.05	20.19
E	0.295	0.325		7.50	8.25
E_1	0.245	0.300		6.23	7.62
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.120	0.160		3.05	4.06
L_2	0.000	0.030		0.000	0.76
a	2°	15°	4	2°	15°
N	16		5	16	
N_1	0		6	0	
Q_1	0.050	0.080		1.27	2.03
S	0.010	0.060		0.254	1.52

92CM-22284R1

(E) SUFFIX
40-Lead Dual-In-Line
Plastic Package

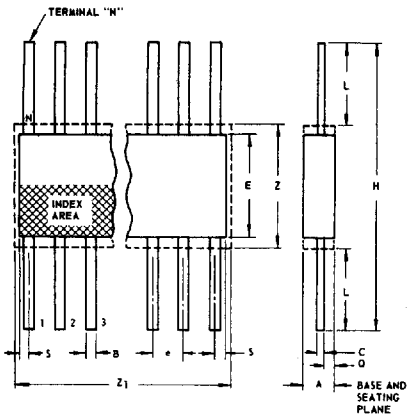
SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.250		3.10	6.30
A_1	0.020	0.070		0.51	1.77
B	0.016	0.020		0.407	0.508
B_1	0.028	0.070		0.72	1.77
C	0.008	0.012	1	0.204	0.304
D	2.000	2.090		50.80	53.09
E_1	0.515	0.580		13.09	14.73
e_1	0.100 TP		2	2.54 TP	
e_A	0.600 TP		2,3	15.24 TP	
L	0.100	0.200		2.54	5.00
L_2	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	40		5	40	
N_1	0		6	0	
Q_1	0.065	0.095		1.66	2.41
S	0.040	0.100		1.02	2.54

92CS-30959

Dimensional Outlines (Cont'd)

Ceramic Flat Packs

(K) SUFFIX (JEDEC MO-004-AF)
14-Lead



SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.008	0.100		0.21	2.54
B	0.015	0.019	1	0.381	0.482
C	0.003	0.006	1	0.077	0.152
e	0.050 TP		2	1.27 TP	
E	0.200	0.300		5.1	7.6
H	0.600	1.000		15.3	25.4
L	0.150	0.350		3.9	8.8
N	14		3	14	
Q	0.005	0.050		0.13	1.27
S	0.000	0.050		0.00	1.27
Z	0.300		4	7.62	
Z_1	0.400		4	10.16	

92SS-4300R3

NOTES:
1. Refer to JEDEC Publication No. 95 for Rules for Dimensioning Peripheral Lead Outlines.
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at maximum material condition.
3. N is the maximum quantity of lead positions.
4. Z and Z_1 determine a zone within which all body and lead irregularities lie.

(K) SUFFIX (JEDEC MO-004-AG)
16-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.008	0.100		0.21	2.54
B	0.015	0.019	1	0.381	0.482
C	0.003	0.006	1	0.077	0.152
e	0.050 TP		2	1.27 TP	
E	0.200	0.300		5.1	7.6
H	0.600	1.000		15.3	25.4
L	0.150	0.350		3.9	8.8
N	16		3	16	
Q	0.005	0.050		0.13	1.27
S	0.000	0.025		0.00	0.63
Z	0.300		4	7.62	
Z_1	0.400		4	10.16	

92CS-17271R3

(K) SUFFIX
24-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.075	0.120		1.91	3.04
B	0.018	0.022	1	0.458	0.558
C	0.004	0.007	1	0.102	0.177
e	0.050 TP		2	1.27 TP	
E	0.600	0.700		15.24	17.78
H	1.150	1.350		29.21	34.29
L	0.225	0.325		5.72	8.25
N	24		3	24	
Q	0.035	0.070		0.89	1.77
S	0.060	0.110	1	1.53	2.79
Z	0.700		4	17.78	
Z_1	0.750		4	19.05	

92CS-19949R2

(K) SUFFIX
28-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.075	0.120		1.91	3.04
B	0.018	0.022	1	0.458	0.558
C	0.004	0.007	1	0.102	0.177
e	0.050 TP		2	1.27 TP	
E	0.600	0.700		15.24	17.78
H	1.150	1.350		29.21	34.29
L	0.225	0.325		5.72	8.25
N	28		3	28	
Q	0.035	0.070		0.89	1.77
S	0	0.060	1	0	1.53
Z	0.700		4	17.78	
Z_1	0.750		4	19.05	

92CS-20972